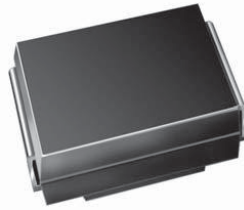




**THE DATASHEET OF
UH2C-E3/52T**



Surface Mount Ultrafast Rectifier


DO-214AA (SMB)

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	100 V, 150 V, 200 V
I_{FSM}	50 A
t_{rr}	25 ns
V_F at $I_F = 2.0$ A	0.69 V
T_J max.	175 °C

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS compliant, commercial grade

Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Device marking code		HB	HC	HD	
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1) ⁽¹⁾	$I_{F(AV)}$	2.0			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	50			A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 175			°C

Note

⁽¹⁾ Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.79	-	V
	I _F = 2.0 A			0.87	1.05	
	I _F = 1.0 A	T _A = 125 °C		0.62	-	
	I _F = 2.0 A			0.69	0.90	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	2.0	μA
		T _A = 125 °C		10	50	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A	T _A = 25 °C	t _{rr}	15	25	ns
Typical reverse recovery time	I _F = 1.0 A, dI/dt = 50 A/μs, V _R = 30 V, I _{rr} = 0.1 I _{RM}			20	35	
Typical softness factor (t _b /t _a)	I _F = 2.0 A, dI/dt = 200 A/μs, V _R = 200 V	T _A = 125 °C	S	0.3	-	
Typical reverse recovery current			I _{RM}	5.0	6.0	A
Typical stored charge			Q _{rr}	55	-	nC
Typical junction capacitance			C _J	42	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	105			°C/W
	R _{θJM} ⁽¹⁾	15			

Note(1) Free air, mounted on recommended copper pad area. Thermal resistance R_{θJA} - junction to ambient, R_{θJM} - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
UH2D-E3/52T	0.100	52T	750	7" diameter plastic tape and reel
UH2D-E3/5BT	0.100	5BT	3200	13" diameter plastic tape and reel
UH2DHE3/52T ⁽¹⁾	0.100	52T	750	7" diameter plastic tape and reel
UH2DHE3/5BT ⁽¹⁾	0.100	5BT	3200	13" diameter plastic tape and reel

Note

(1) AEC-Q 101 qualified



RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

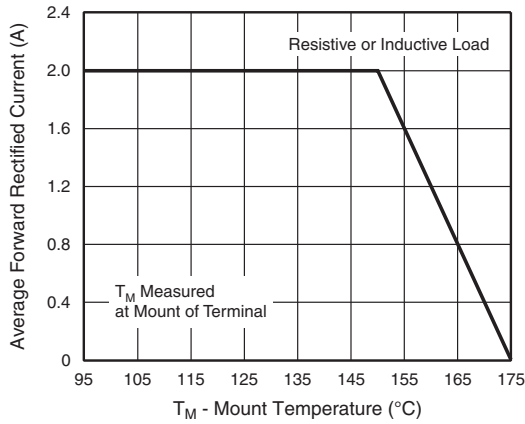


Fig. 1 - Maximum Forward Current Derating Curve

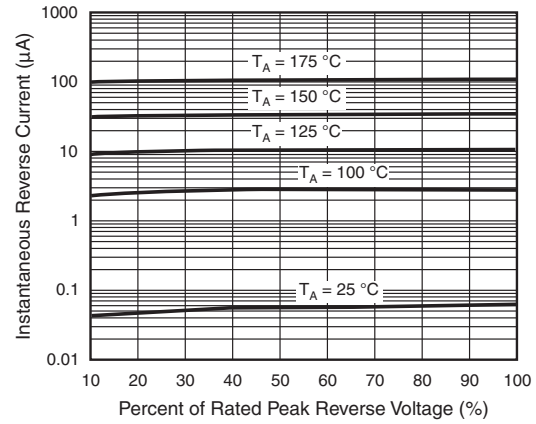


Fig. 4 - Typical Reverse Characteristics

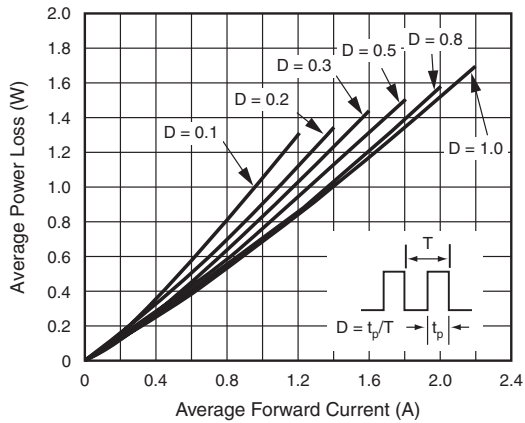


Fig. 2 - Forward Power Loss Characteristics

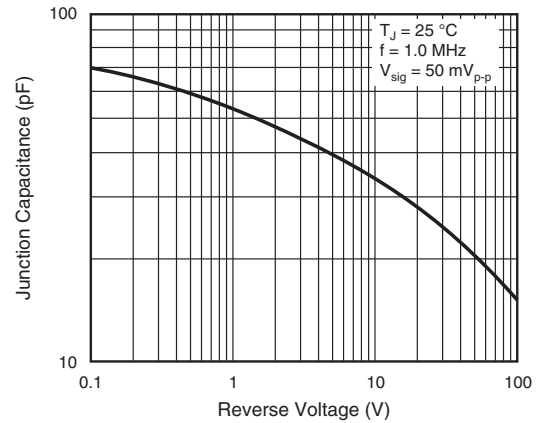


Fig. 5 - Typical Junction Capacitance

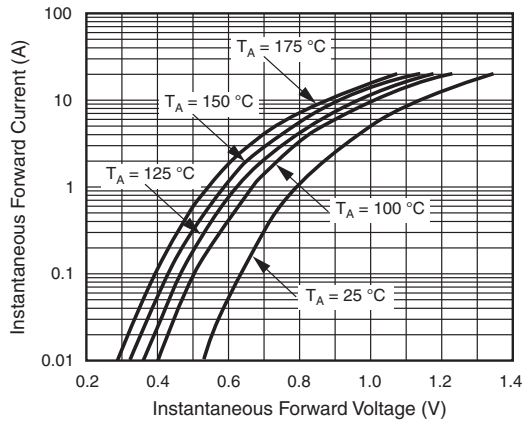


Fig. 3 - Typical Instantaneous Forward Characteristics

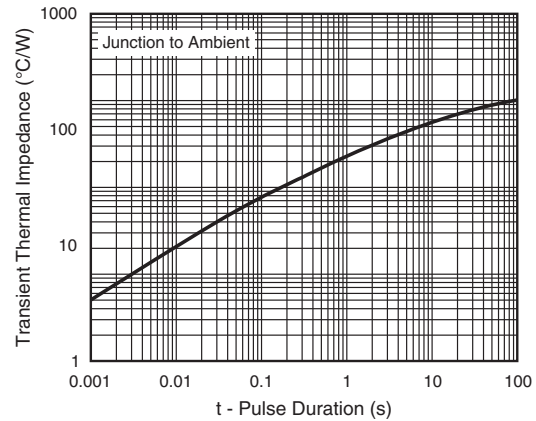
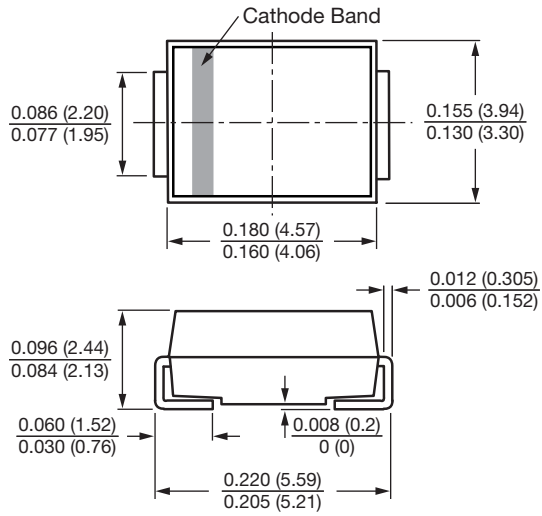


Fig. 6 - Typical Transient Thermal Impedance

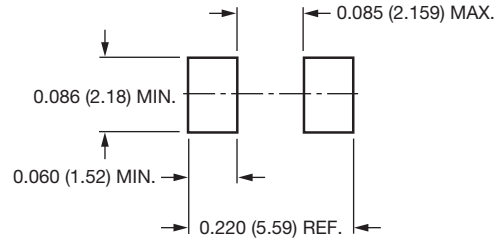


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout





Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy


Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View UH2C-E3/52T on WIN SOURCE](#)

 [Vishay Information](#)

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management